12 V, 8.0 A, Low V_{CE(sat)} **NPN Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage ($V_{CE(sat)}$) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC-DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

• This is a Pb-Free Device

MAXIMUM RATINGS (T_A = 25°C)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	12	Vdc
Collector-Base Voltage	V _{CBO}	12	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current - Continuous	Ι _C	6.0	Adc
Collector Current - Peak	I _{CM}	8.0	А
Electrostatic Discharge	ESD	HBM Class 3B MM Class C	

Characteristic	Symbol	Max	Unit
Total Device Dissipation, $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D (Note 1)	830 6.7	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 1)	150	°C/W
Total Device Dissipation, $T_A = 25^{\circ}C$ Derate above 25°C	P _D (Note 2)	1.4 11.1	W mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 2)	90	°C/W
Thermal Resistance, Junction-to-Lead #1	$R_{\theta JL}$ (Note 2)	15	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

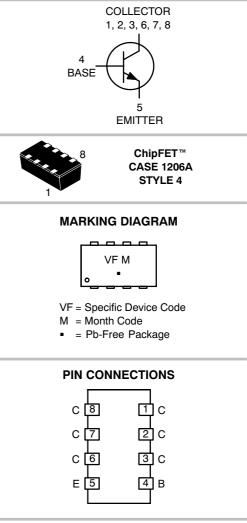
FR-4 @ 100 mm², 1 oz copper traces.
 FR-4 @ 500 mm², 1 oz copper traces.



ON Semiconductor®

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12 VOLTS, 8.0 AMPS NPN LOW $V_{CE(sat)}$ TRANSISTOR EQUIVALENT $R_{DS(on)}$ 30 m Ω



ORDERING INFORMATION

Device	Package	Shipping [†]
NSS12601CF8T1G	ChipFET (Pb-Free)	3000/ Tape & Reel

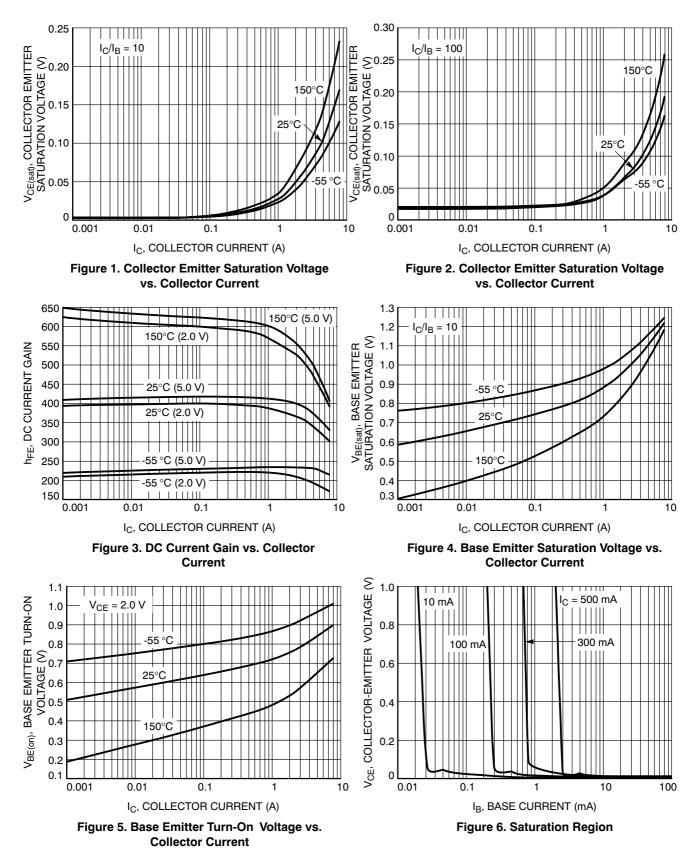
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS					•
Collector-Emitter Breakdown Voltage $(I_C = 10 \text{ mAdc}, I_B = 0)$	V _{(BR)CEO}	12	-	-	Vdc
Collector-Base Breakdown Voltage $(I_{C} = 0.1 \text{ mAdc}, I_{E} = 0)$	V _{(BR)CBO}	12	-	-	Vdc
Emitter-Base Breakdown Voltage $(I_E = 0.1 \text{ mAdc}, I_C = 0)$	V _{(BR)EBO}	6.0	-	-	Vdc
Collector Cutoff Current ($V_{CB} = 12 \text{ Vdc}, I_E = 0$)	I _{CBO}	-	-	0.1	μAdc
Emitter Cutoff Current (V _{EB} = 6.0 Vdc)	I _{EBO}	-	-	0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain (Note 3) ($I_C = 10 \text{ mA}, V_{CE} = 2.0 \text{ V}$) ($I_C = 500 \text{ mA}, V_{CE} = 2.0 \text{ V}$) ($I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$) ($I_C = 2.0 \text{ A}, V_{CE} = 2.0 \text{ V}$) ($I_C = 3.0 \text{ A}, V_{CE} = 2.0 \text{ V}$)	h _{FE}	200 200 200 200 200	- - 395 -	- - - - -	
Collector-Emitter Saturation Voltage (Note 3) ($I_{C} = 0.1 \text{ A}, I_{B} = 0.010 \text{ A}$) ($I_{C} = 1.0 \text{ A}, I_{B} = 0.100 \text{ A}$) ($I_{C} = 1.0 \text{ A}, I_{B} = 0.010 \text{ A}$) ($I_{C} = 2.0 \text{ A}, I_{B} = 0.020 \text{ A}$) ($I_{C} = 3.0 \text{ A}, I_{B} = 0.030 \text{ A}$) ($I_{C} = 4.0 \text{ A}, I_{B} = 0.400 \text{ A}$)	V _{CE(sat)}	- - - - -	0.007 0.030 0.045 0.055 0.080 0.090	0.010 0.050 0.060 0.070 0.110 0.120	V
Base-Emitter Saturation Voltage (Note 3) $(I_C = 1.0 \text{ A}, I_B = 0.01 \text{ A})$	V _{BE(sat)}	-	0.760	0.900	V
Base-Emitter Turn-on Voltage (Note 3) ($I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V}$)	V _{BE(on)}	-	0.720	0.900	V
Cutoff Frequency (I _C = 100 mA, V _{CE} = 5.0 V, f = 100 MHz)	f _T	140	-	-	MHz
Input Capacitance (V _{EB} = 0.5 V, f = 1.0 MHz)	Cibo	-	-	1000	pF
Output Capacitance (V _{CB} = 3.0 V, f = 1.0 MHz)	Cobo	-	-	200	pF
SWITCHING CHARACTERISTICS	· · · ·				•
Delay (V _{CC} = 10 V, I _C = 750 mA, I _{B1} = 15 mA)	t _d	-	-	110	ns
Rise (V _{CC} = 10 V, I _C = 750 mA, I _{B1} = 15 mA)	t _r	-	-	140	ns
Storage (V _{CC} = 10 V, I _C = 750 mA, I _{B1} = 15 mA)	t _s	-	-	550	ns
Fall (V _{CC} = 10 V, I _C = 750 mA, I _{B1} = 15 mA)	t _f	-	-	140	ns

3. Pulsed Condition: Pulse Width = 300 $\mu sec,$ Duty Cycle \leq 2%.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

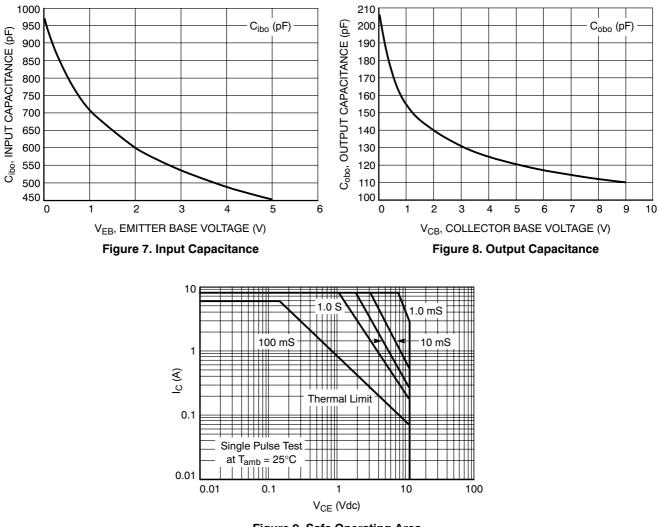
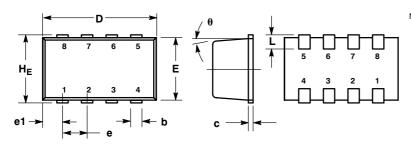
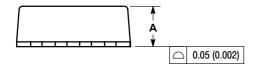


Figure 9. Safe Operating Area

PACKAGE DIMENSIONS

ChipFET[™] CASE 1206A-03 ISSUE H





NOTES:

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 MOLD GATE BURRS SHALL NOT EXCEED 0.13 MM PER SIDE.
 LEADFRAME TO MOLDED BODY OFFSET IN HORIZONTAL AND VERTICAL SHALL NOT EXCEED 0.08 MM.
 DIMENSIONS A AND B EXCLUSIVE OF MOLD GATE BURRS.
- NO MOLD FLASH ALLOWED ON THE TOP AND BOTTOM LEAD SURFACE. 6.

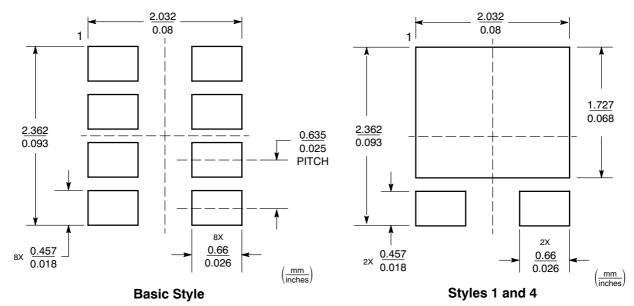
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.00	1.05	1.10	0.039	0.041	0.043
b	0.25	0.30	0.35	0.010	0.012	0.014
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
Е	1.55	1.65	1.70	0.061	0.065	0.067
е	0.65 BSC			0.025 BSC		
e1	0.55 BSC			0.022 BSC		
L	0.28	0.35	0.42	0.011	0.014	0.017
HE	1.80	1.90	2.00	0.071	0.075	0.079
θ	5° NOM			5° NOM		

STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. COLLECTOR 4. BASE 5. EMITTER 6. COLLECTOR

6. COLLECTOR 7. COLLECTOR

8. COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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